SCOPE:

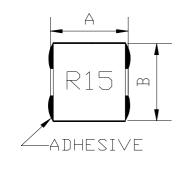
This specification applies to the Pb Free high current type SMD inductors for MSI-700705F-SERIES

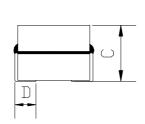
PRODUCT INDENTIFICATION

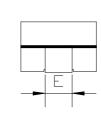
MSI-700705F-R15 M

- 1
- 2
- 3 4
- ① Product Code
- 2 Dimensions Code
- **3 Inductance Code**
- **4** Tolerance Code

(1) SHAPES AND DIMENSIONS







A: 7.0 Max. mm
B: 7.0 Max. mm
C: 4.96 Max. mm
D: 1.52 Typ. mm
E: 2.49 Typ. mm

(2) ELECTRICAL SPECIFICATIONS SEE TABLE 1

TEST INSTRUMENTS

L: HP 4284A PRECISION LCR METER (or equivalent)

RDC: CHROMA MODEL 16502 MILLIOHMMETER (or equivalent)

IDC1: CH3302/G LCR METER

CH1320,CH1320S BIAS CURRENT SOURCE(or equivalent)

(3) CHARACTERISTICS

(3)-1 Ambient temperature +60°C Max.

(3)-2 Operate temperature range -40° C $\sim +125^{\circ}$ C (Including self temp. rise)

(3)-3 Storage temperature range -40° C $\sim +125^{\circ}$ C



TABLE 1

| MAGLAYERS | Inductance | Percent | Test | Resistance | sistance Rated DC Current | | Marking |
|-----------------|------------|-----------|-------------|------------|---------------------------|---------|---------|
| PT/NO. | L(µH) | Tolerance | Frequency | RDC(mΩ) | IDC1(A) | IDC2(A) | Warking |
| MSI-700705-72N | 0.072 | M,N | 100kHz/0.1V | 0.32 ±9.4% | 58 | 31 | 72N |
| MSI-700705-R10□ | 0.10 | M,N | 100kHz/0.1V | 0.32 ±9.4% | 46 | 31 | R10 |
| MSI-700705-R15 | 0.15 | M,N | 100kHz/0.1V | 0.32 ±9.4% | 30 | 31 | R15 |

※ ☐ specify the inductance tolerance,M(±20%),N(±30%)

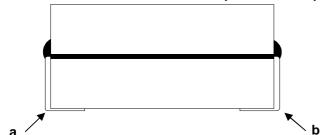
※ IDC1: Based on inductance change (△L/Lo: drop 20% TYP.)@ ambient temp. 25°C

IDC2: Based on temperature rise (△T: 40°C TYP.)

Rated DC Current: The less value which is IDC1 or IDC2.

RDC TEST POINT

The nominal DCR is measured from point "a" to point "b" .



(4) RELIABILITY TEST METHOD

MECHANICAL

| TEST ITEM | SPECIFICATION | TEST DETAILS |
|-------------------|-----------------|---|
| Substrate bending | ∆L/Lo≦±5% | The sample shall be soldered onto the printed circuit board |
| | | in figure 1 and a load applied unitil the figure in the arrow |
| | There shall be | direction is made approximately 3mm.(keep time 30 seconds) |
| | no mechanical | PCB dimension shall the page 7/9 |
| | damage or elec- | F(Pressurization) |
| | trical damege. | л |
| | | R5 45±2 45±2 10 20 R340 |
| | | PRESSURE ROD figure-1 |
| Vibration | ∆L/Lo≦±5% | The sample shall be soldered onto the printed circuit board |
| | | and when a vibration having an amplitude of 1.52mm |
| | There shall be | and a frequency of from 10 to 55Hz/1 minute repeated should |
| | no mechanical | be applied to the 3 directions (X,Y,Z) for 2 hours each. |
| | damage. | (A total of 6 hours) |
| Solderability | New solder | Flux (rosin, isopropyl alcohol{JIS-K-1522}) shall be coated |
| Coluciasinty | More than 90% | over the whole of the sample before hard, the sample shall |
| | | then be preheated for about 2 minutes in a temperature of |
| | | 130∼150℃ and after it has been immersed to a depth 0.5mm |
| | | below for 3±0.2 seconds fully in molten solder M705 with |
| | | a temperature of 245±5℃. |
| | | More than 90% of the electrode sections shall be couered |
| | | with new solder smoothly when the sample is taken out of |
| | | the solder bath. |
| | | |

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MECHANICAL

| TEST ITEM | | SPECIFICATION | | | | |
|---------------------------------|-----------------------------|---|--|--|--|--|
| Resistance to Soldering heat | There shall be no damage or | Temperature profile of reflow soldering | | | | |
| (reflow soldering) | problems. | Soldering (Peak temperature 260±3° 10 sec 150 150 Pre-heating Slow cooling (Stored at room temperature) The specimen shall be passed through the reflow oven with the condition shown in the above profile for 1 time. The specimen shall be stored at standard atmospheric conditions for 1 hour, after which the measurement shall be made. | | | | |

ELECTRICAL

| TEST ITEM | SPECIFICATION | TEST DETAILS |
|-----------------|----------------|--|
| Temperature | ∆L/L20°C ≦±10% | The test shall be performed after the sample has stabilized in |
| characteristics | 0~2000 ppm/℃ | an ambient temperature of -20 to +85℃,and the value |
| | | calculated based on the value applicable in a normal |
| | | temperature and narmal humidity shall be △L/L20°C ≦±10%. |
| | | |
| | | |
| | | |

ENVIROMENT CHARACTERISTICS

| | SPECIFICATION | | | | | |
|------------------|----------------|---|--|--------------------|--|--|
| High temperature | ∆L/Lo≦±5% | The sample shall be left for 96±4 hours in an atmospere with | | | | |
| storage | | a temperature of 85±2℃ and a normal humidity. | | | | |
| | There shall be | Upon completion of the measurement shall be made after the | | | | |
| | no mechanical | sample has beer | n left in a normal temp | erature and normal | | |
| | damage. | humidity for 1 h | our. | | | |
| Low temperature | ∆L/Lo≦±5% | The sample shall be left for 96±4 hours in an atmosphere with | | | | |
| storage | | a temperature of -25±3℃. | | | | |
| J | There shall be | Upon completion of the test, the measurement shall be made | | | | |
| | no mechanical | | after the sample has been left in a normal temperature and | | | |
| | damage. | | normal humidity for 1 hour. | | | |
| Change of | ∆L/Lo≦±5% | | The sample shall be subject to 5 continuos cycles, such as shown | | | |
| temperature | | in the table 2 below and then it shall be subjected to standard | | | | |
| | There shall be | atmospheric cor | atmospheric conditions for 1 hour, after which measurement | | | |
| | no other dama- | shall be made. | | | | |
| 1 | ge of problems | | | | | |
| | | | table 2 | | | |
| | | | Temperature | Duration | | |
| | | 1 | −25±3 °C | 30 min. | | |
| | | | (Themostat No.1) | ou min. | | |
| | | 2 | Standard | | | |
| | | | atmospheric | No.1→No.2 | | |
| | | 3 | 85±2 ℃ | 20 min | | |
| | | | (Themostat No.2) | 30 min. | | |
| | | 4 | Standard | | | |
| | | 4 | atmospheric | No.2→No.1 | | |
| Moisture storage | ∆L/Lo≦±5% | The sample shal | The sample shall be left for 96±4 hours in a temperature of | | | |
| | | 40±2℃ and a hu | 40±2°C and a humidity(RH) of 90∼95%. | | | |
| | There shall be | Upon completion of the test, the measurement shall be made | | | | |
| | no mechanical | after the sample has been left in a normal temperature and | | | | |
| | ĺ | | more than 1 hour. | | | |



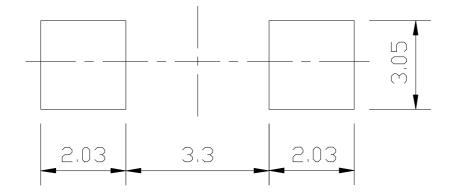
(5) LAND DIMENSION (Ref.)

PCB: GLASS EPOXY t=1.6mm

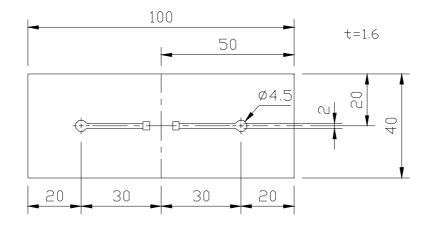
(5)-1 LAND PATTERN DIMENSIONS(mm)

(STANDARD PATTERN)

Unit:mm



(5)-2 SUBSTRATE BENDING TEST BENDING TEST BOARD

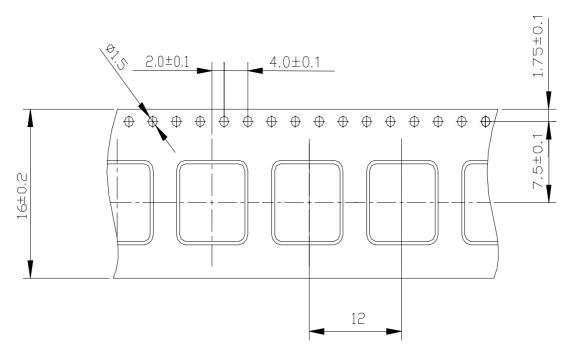


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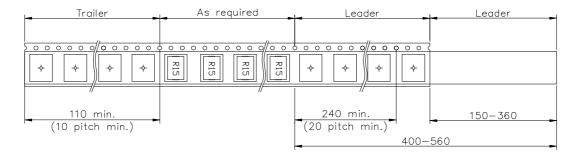
(6) PACKAGING

(6)-1 CARRIER TAPE DIMENSIONS (mm)

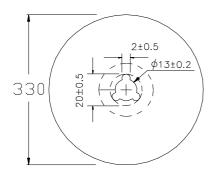


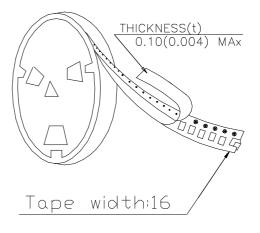
(6)-2 TAPING DIMENSIONS (mm)





(6)-3 REEL DIMENSIONS (mm)





(6)-4 QUANTITY

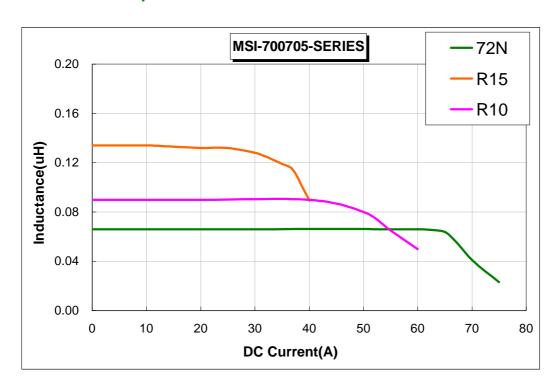
1000pcs/Reel

The products are packaged so that no damage will be sustained.



TYPICAL ELECTRICAL CHARACTERISTICS

INDUCTANCE vs. DC CURRENT@100kHz/0.1V Ambient Temperature : 25°C



Temperature Rise vs. DC Current

